imall

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Ordering Information

Data Sheet

March 26, 2007

Medium Power Differential Line Driver

The EL1509 is a dual operational amplifier designed for customer premise line driving in DMT ADSL solutions. This device features a high drive capability of 250mA while consuming only 7.1mA of supply current per amplifier and operating from a single 5V to 12V supply. This driver achieves a typical distortion of less than -85dBc, at 150kHz into a 25Ω load. The EL1509 is available in the industry standard 8 Ld SOIC as well as the thermally-enhanced 8 Ld DFN package. Both are specified for operation over the full -40°C to +85°C temperature range.

The EL1509 is ideal for ADSL, SDSL, HDSL2 and VDSL line driving applications.

5				
PART NUMBER	PART MARKING	TAPE & REEL	PACKAGE	PKG. DWG. #
EL1509CS	1509CS	-	8 Ld SOIC	MDP0027
EL1509CS-T7	1509CS	7"	8 Ld SOIC	MDP0027
EL1509CS-T13	1509CS	13"	8 Ld SOIC	MDP0027
EL1509CSZ (See Note)	1509CSZ	-	8 Ld SOIC (Pb-Free)	MDP0027
EL1509CSZ-T7 (See Note)	1509CSZ	7"	8 Ld SOIC (Pb-Free)	MDP0027
EL1509CSZ-T13 (See Note)	1509CSZ	13"	8 Ld SOIC (Pb-Free)	MDP0027
EL1509CL	1509CL	-	8 Ld DFN	MDP0047
EL1509CL-T7	1509CL	7"	8 Ld DFN	MDP0047
EL1509CL-T13	1509CL	13"	8 Ld DFN	MDP0047

 EL1509CL-T13
 1509CL
 13"
 8 Ld DFN
 MDP0047

 NOTE:
 Intersil Pb-free plus anneal products employ special Pb-free material sets; molding compounds/die attach materials and 100% matte tin plate termination finish, which are RoHS compliant and compatible with both SnPb and Pb-free soldering operations. Intersil Pb-free products are MSL classified at Pb-free peak reflow temperatures that meet or exceed the Pb-free requirements of IPC/JEDEC J STD-020.

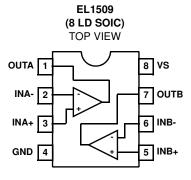
Features

- Drives up to 250mA from a +12V supply
- + $20V_{P-P}$ differential output drive into 100Ω
- -85dBc typical driver output distortion at full output at 150kHz
- · Low quiescent current of 7.5mA per amplifier
- · Pb-free plus anneal available (RoHS compliant)

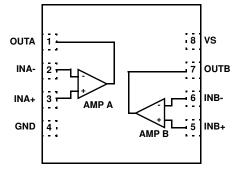
Applications

- ADSL G.lite CO line driving
- · ADSL full rate CPE line driving
- G.SHDSL, HDSL2 line driver
- Video distribution amplifier
- · Video twisted-pair line driver

Pinouts







CAUTION: These devices are sensitive to electrostatic discharge; follow proper IC Handling Procedures. 1-888-INTERSIL or 1-888-468-3774 | Intersil (and design) is a registered trademark of Intersil Americas Inc. Copyright © Intersil Americas Inc. 2002-2004, 2007. All Rights Reserved. All other trademarks mentioned are the property of their respective owners.

1

Absolute Maximum Ratings (T_A = +25°C)

V _S + Voltage to Ground
V _{IN+} Voltage GND to V _{S+}
Current into any Input
Continuous Output Current

 Operating Temperature
 -40°C to +85°C

 Storage Temperature Range
 -60°C to +150°C

 Operating Junction Temperature
 -40°C to +150°C

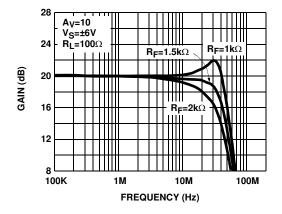
 Power Dissipation
 See Curves

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

IMPORTANT NOTE: All parameters having Min/Max specifications are guaranteed. Typical values are for information purposes only. Unless otherwise noted, all tests are at the specified temperature and are pulsed tests, therefore: $T_J = T_C = T_A$

PARAMETER	DESCRIPTION	CONDITIONS	MIN	TYP	MAX	UNIT
AC PERFORM	ANCE		L.	4	1	1
BW	-3dB Bandwidth	A _V = +4		70		MHz
HD	Total Harmonic Distortion	f = 150kHz, V_{O} = 16 V_{P-P} , R_{L} = 25 Ω		-85		dBc
dG	Differential Gain	$A_V = +2, R_L = 37.5\Omega$		0.15		%
dθ	Differential Phase	$A_V = +2, R_L = 37.5\Omega$		0.1		0
SR	Slewrate	V _{OUT} from -3V to +3V	350	500		V/µs
DC PERFORM	ANCE		W	4		
V _{OS}	Offset Voltage		-20		20	mV
ΔV_{OS}	V _{OS} Mismatch		-10		10	mV
R _{OL}	Transimpedance	V _{OUT} from -4.5V to +4.5V	0.7	1.4	2.5	MΩ
INPUT CHARA	CTERISTICS			1		1
I _B +	Non-Inverting Input Bias Current		-5		5	μA
I _B -	Inverting Input Bias Current		-30		30	μA
Δl _B -	IB- Mismatch		-30		30	μA
e _N	Input Noise Voltage			2.8		nV∕√Hz
i _N	-Input Noise Current			19		pA∕√Hz
OUTPUT CHAR	ACTERISTICS		W	4		
V _{OUT}	Loaded Output Swing (single ended)	$V_{S} = \pm 6V, R_{L} = 100\Omega$ to GND	±4.8	±5		V
		$V_S = \pm 6V$, $R_L = 25\Omega$ to GND	±4.4	±4.7		V
IOUT	Output Current	$R_L = 0\Omega$		450		mA
SUPPLY			i.			
V _S	Supply Voltage	Single Supply	5		12	V
IS	Supply Current	All Outputs at Mid Supply		14.2	18	mA

$$\label{eq:Electrical Specifications} \begin{split} & \mathsf{V}_S = +12\mathsf{V}, \, \mathsf{R}_F = 1.5 \mathsf{k}\Omega, \, \mathsf{R}_L = 100\Omega \text{ connected to mid supply}, \, \mathsf{T}_A = 25^\circ\mathsf{C}, \, \mathsf{unless otherwise specified}. \end{split}$$





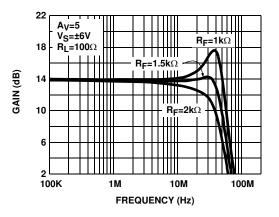


FIGURE 3. DIFFERENTIAL FREQUENCY RESPONSE vs R_F (EL1509CS)

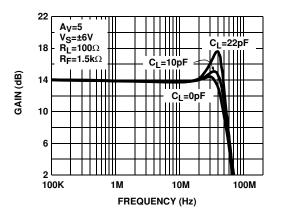


FIGURE 5. DIFFERENTIAL FREQUENCY RESPONSE vs CL (EL1509CS)

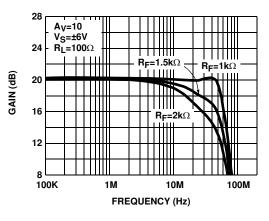


FIGURE 2. DIFFERENTIAL FREQUENCY RESPONSE vs R_F (EL1509CL)

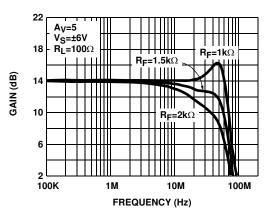


FIGURE 4. DIFFERENTIAL FREQUENCY RESPONSE vs R_F (EL1509CL)

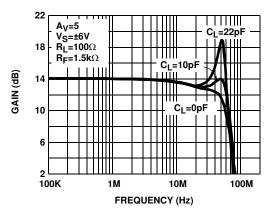


FIGURE 6. DIFFERENTIAL FREQUENCY RESPONSE vs CL (EL1509CL)

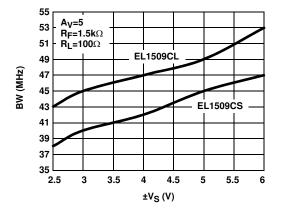


FIGURE 7. DIFFERENTIAL BANDWIDTH vs SUPPLY VOLTAGE

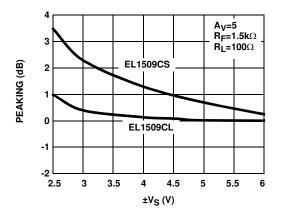


FIGURE 9. DIFFERENTIAL PEAKING vs SUPPLY VOLTAGE

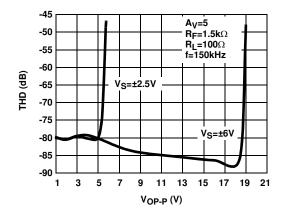


FIGURE 11. DIFFERENTIAL TOTAL HARMONIC DISTORTION vs DIFFERENTIAL OUTPUT VOLTAGE (ALL PACKAGES)

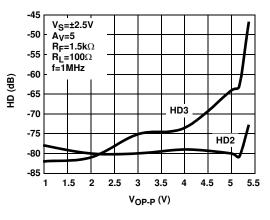


FIGURE 8. DIFFERENTIAL HARMONIC DISTORTION vs DIFFERENTIAL OUTPUT VOLTAGE (ALL PACKAGES)

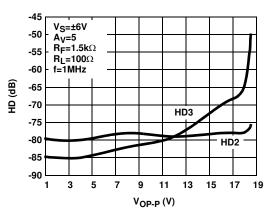
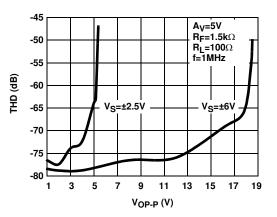
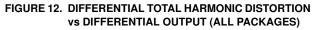


FIGURE 10. DIFFERENTIAL HARMONIC DISTORTION vs DIFFERENTIAL OUTPUT VOLTAGE (ALL PACKAGES)





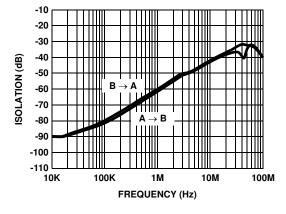


FIGURE 13. CHANNEL ISOLATION vs FREQUENCY

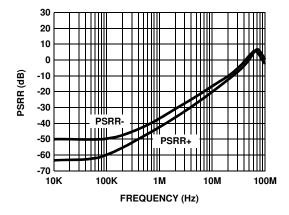


FIGURE 15. POWER SUPPLY REJECTION vs FREQUENCY

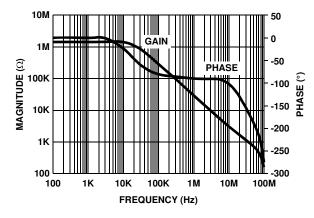


FIGURE 17. TRANSIMEDANCE (ROL) vs FREQUENCY

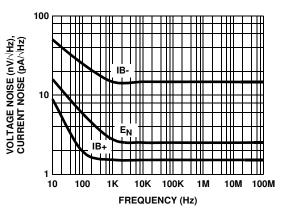


FIGURE 14. VOLTAGE AND CURRENT NOISE vs FREQUENCY

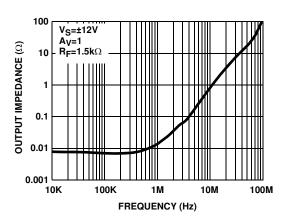


FIGURE 16. OUTPUT IMPEDANCE vs FREQUENCY

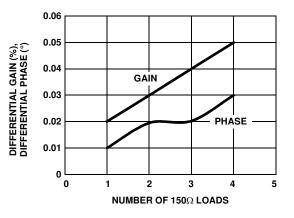


FIGURE 18. DIFFERENTIAL GAIN & PHASE

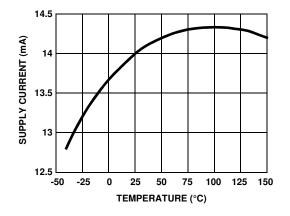


FIGURE 19. SUPPLY CURRENT vs TEMPERATURE

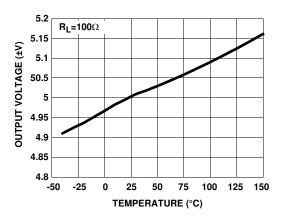


FIGURE 21. OUTPUT VOLTAGE vs TEMPERATURE

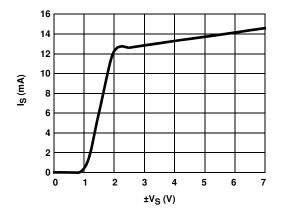


FIGURE 23. SUPPLY CURRENT vs SUPPLY VOLTAGE

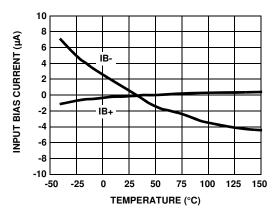


FIGURE 20. INPUT BIAS CURRENT vs TEMPERATURE

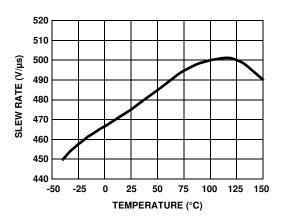


FIGURE 22. SLEW RATE vs TEMPERATURE

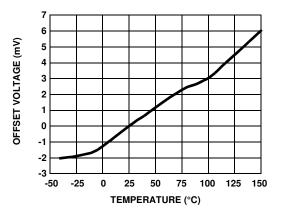


FIGURE 24. OFFSET VOLTAGE vs TEMPERATURE

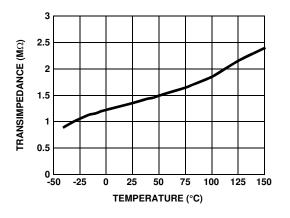


FIGURE 25. TRANSIMEDANCE vs TEMPERATURE

JEDEC JESD51-7 HIGH EFFECTIVE THERMAL CONDUCTIVITY (4-LAYER) TEST BOARD (DFN EXPOSED DIEPAD SOLDERED TO PCB PER JESD51-5) 3.5 2.907W 3 POWER DISSIPATION (W) OFNO 2.5 2 1.5 1 136W SO8 110°C/W 0.5 0 0 25 50 75 85 100 125 150 **AMBIENT TEMPERATURE (°C)**

FIGURE 27. PACKAGE POWER DISSIPATION vs AMBIENT TEMPERATURE

Applications Information

Product Description

The EL1509 is a dual operational amplifier designed for customer premise line driving in DMT ADSL solutions. It is a dual current mode feedback amplifier with low distortion while drawing moderately low supply current. It is built using Elantec's proprietary complimentary bipolar process and is offered in industry standard pin-outs. Due to the current feedback architecture, the EL1509 closed-loop 3dB bandwidth is dependent on the value of the feedback resistor. First the desired bandwidth is selected by choosing the feedback resistor, R_{F} , and then the gain is set by picking the gain resistor, R_{G} . The curves at the beginning of the Typical Performance Curves section show the effect of varying both R_{F} and R_{G} . The 3dB bandwidth is somewhat dependent on the power supply voltage.

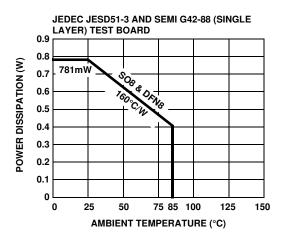


FIGURE 26. PACKAGE POWER DISSIPATION vs AMBIENT TEMPERATURE

Power Supply Bypassing and Printed Circuit Board Layout

As with any high frequency device, good printed circuit board layout is necessary for optimum performance. Ground plane construction is highly recommended. Lead lengths should be as short as possible, below 1/4". The power supply pins must be well bypassed to reduce the risk of oscillation. A 1.0 μ F tantalum capacitor in parallel with a 0.01 μ F ceramic capacitor is adequate for each supply pin.

For good AC performance, parasitic capacitances should be kept to a minimum, especially at the inverting input. This implies keeping the ground plane away from this pin. Carbon resistors are acceptable, while use of wire-wound resistors should not be used because of their parasitic inductance. Similarly, capacitors should be low inductance for best performance.

Capacitance at the Inverting Input

Due to the topology of the current feedback amplifier, stray capacitance at the inverting input will affect the AC and transient performance of the EL1509 when operating in the non-inverting configuration.

In the inverting gain mode, added capacitance at the inverting input has little effect since this point is at a virtual ground and stray capacitance is therefore not "seen" by the amplifier.

Feedback Resistor Values

The EL1509 has been designed and specified with $R_F = 1.5k\Omega$ for $A_V = +5$. This value of feedback resistor yields extremely flat frequency response with little to no peaking out to 50MHz. As is the case with all current feedback amplifiers, wider bandwidth, at the expense of slight peaking, can be obtained by reducing the value of the feedback resistor. Inversely, larger values of feedback resistor will cause rolloff to occur at a lower frequency. See the curves in the Typical Performance Curves section which show 3dB bandwidth and peaking vs. frequency for various feedback resistors and various supply voltages.

Bandwidth vs Temperature

Whereas many amplifier's supply current and consequently 3dB bandwidth drop off at high temperature, the EL1509 was designed to have little supply current variations with temperature. An immediate benefit from this is that the 3dB bandwidth does not drop off drastically with temperature.

Supply Voltage Range

The EL1509 has been designed to operate with supply voltages from $\pm 2.5V$ to $\pm 6V$. Optimum bandwidth, slew rate, and video characteristics are obtained at higher supply voltages. However, at $\pm 2.5V$ supplies, the 3dB bandwidth at A_V = +2 is a respectable 40MHz.

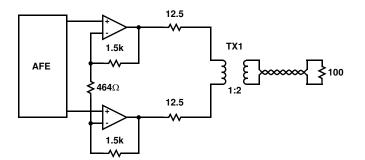
Single Supply Operation

If a single supply is desired, values from +5V to +12V can be used as long as the input common mode range is not exceeded. When using a single supply, be sure to either 1) DC bias the inputs at an appropriate common mode voltage and AC couple the signal, or 2) ensure the driving signal is within the common mode range of the EL1509.

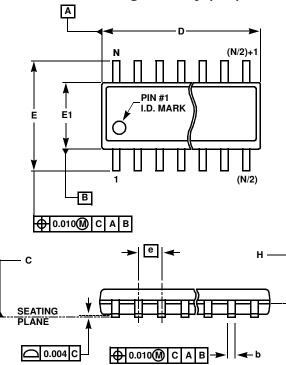
ADSL CPE Applications

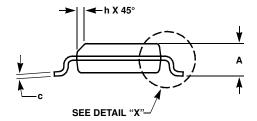
The EL1509 is designed as a line driver for ADSL CPE modems. It is capable of outputting 250mA of output current with a typical supply voltage headroom of 1.3V. It can achieve -85dBc of distortion at low 7.1mA of supply current per amplifier.

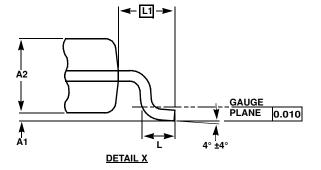
The average line power requirement for the ADSL CPE application is 13dBm (20mW) into a 100Ω line. The average line voltage is $1.41V_{RMS}$. The ADSL DMT peak to average ratio (crest factor) of 5.3 implies peak voltage of 7.5V into the line. Using a differential drive configuration and transformer coupling with standard back termination, a transformer ratio of 1:2 is selected. The circuit configuration is as shown below.



Small Outline Package Family (SO)







MDP0027

SMALL OUTLINE PACKAGE FAMILY (SO)

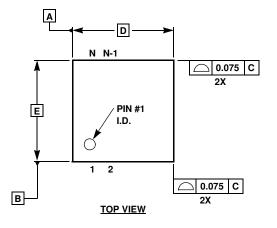
	INCHES								
SYMBOL	SO-8	SO-14	SO16 (0.150")	SO16 (0.300") (SOL-16)	SO20 (SOL-20)	SO24 (SOL-24)	SO28 (SOL-28)	TOLERANCE	NOTES
А	0.068	0.068	0.068	0.104	0.104	0.104	0.104	MAX	-
A1	0.006	0.006	0.006	0.007	0.007	0.007	0.007	±0.003	-
A2	0.057	0.057	0.057	0.092	0.092	0.092	0.092	±0.002	-
b	0.017	0.017	0.017	0.017	0.017	0.017	0.017	±0.003	-
С	0.009	0.009	0.009	0.011	0.011	0.011	0.011	±0.001	-
D	0.193	0.341	0.390	0.406	0.504	0.606	0.704	±0.004	1, 3
Е	0.236	0.236	0.236	0.406	0.406	0.406	0.406	±0.008	-
E1	0.154	0.154	0.154	0.295	0.295	0.295	0.295	±0.004	2, 3
е	0.050	0.050	0.050	0.050	0.050	0.050	0.050	Basic	-
L	0.025	0.025	0.025	0.030	0.030	0.030	0.030	±0.009	-
L1	0.041	0.041	0.041	0.056	0.056	0.056	0.056	Basic	-
h	0.013	0.013	0.013	0.020	0.020	0.020	0.020	Reference	-
Ν	8	14	16	16	20	24	28	Reference	-

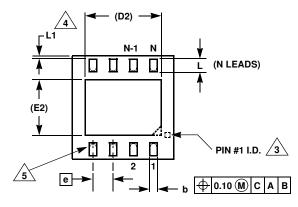
Rev. M 2/07

NOTES:

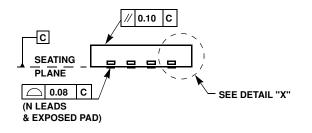
- 1. Plastic or metal protrusions of 0.006" maximum per side are not included.
- 2. Plastic interlead protrusions of 0.010" maximum per side are not included.
- 3. Dimensions "D" and "E1" are measured at Datum Plane "H".
- 4. Dimensioning and tolerancing per ASME Y14.5M-1994

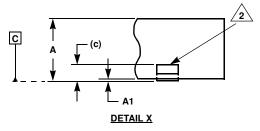
Dual Flat No-Lead Package Family (DFN)





BOTTOM VIEW





MDP0047

DUAL FLAT NO-LEAD PACKAGE FAMILY (JEDEC REG: MO-229)

	MILLI	METERS	
SYMBOL	DFN8 DFN10		TOLERANCE
А	0.85	0.90	±0.10
A1	0.02	0.02	+0.03/-0.02
b	0.30	0.25	±0.05
С	0.20	0.20	Reference
D	4.00	3.00	Basic
D2	3.00	2.25	Reference
E	4.00	3.00	Basic
E2	2.20	1.50	Reference
е	0.80	0.50	Basic
L	0.50	0.50	±0.10
L1	0.10	0	Maximum

NOTES:

Rev. 2 2/07

- 1. Dimensioning and tolerancing per ASME Y14.5M-1994.
- 2. Exposed lead at side of package is a non-functional feature.
- 3. Bottom-side pin #1 I.D. may be a diepad chamfer, an extended tiebar tab, or a small square as shown.
- 4. Exposed leads may extend to the edge of the package or be pulled back. See dimension "L1".
- 5. Inward end of lead may be square or circular in shape with radius (b/2) as shown.
- 6. N is the total number of leads on the device.

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